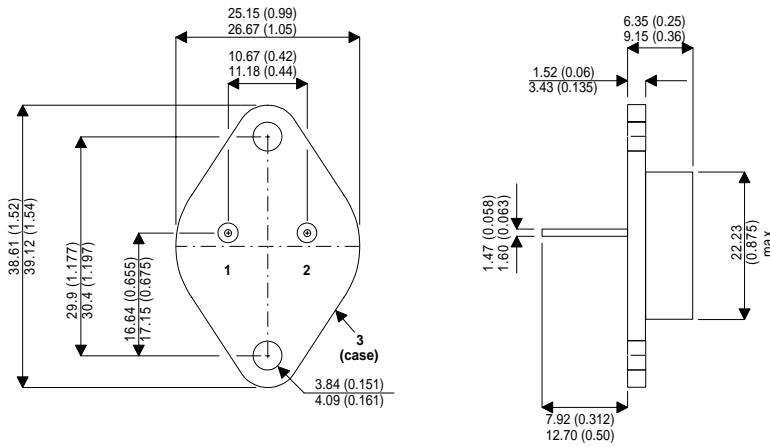


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TO-3 Package Outline.

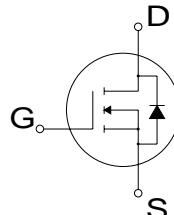
Dimensions in mm (inches)



**N-CHANNEL
ENHANCEMENT MODE
HIGH VOLTAGE
POWER MOSFETS**

V_{DSS} **600V**
I_{D(cont)} **17.5A**
R_{DS(on)} **0.320Ω**

- Faster Switching
- Lower Leakage
- TO-3 Hermetic Package



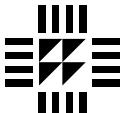
StarMOS is a new generation of high voltage N-Channel enhancement mode power MOSFETs. This new technology minimises the JFET effect, increases packing density and reduces the on-resistance. StarMOS also achieves faster switching speeds through optimised gate layout.

ABSOLUTE MAXIMUM RATINGS ($T_{case} = 25^\circ\text{C}$ unless otherwise stated)

V_{DSS}	Drain – Source Voltage	600	V
I_D	Continuous Drain Current	17.5	A
I_{DM}	Pulsed Drain Current ¹	70	A
V_{GS}	Gate – Source Voltage	± 30	V
V_{GSM}	Gate – Source Voltage Transient	± 40	
P_D	Total Power Dissipation @ $T_{case} = 25^\circ\text{C}$	235	W
	Derate Linearly	1.88	$\text{W}/^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to 150	$^\circ\text{C}$
	Lead Temperature : 0.063" from Case for 10 Sec.	300	
I_{AR}	Avalanche Current ¹ (Repetitive and Non-Repetitive)	17.5	A
E_{AR}	Repetitive Avalanche Energy ¹	30	
E_{AS}	Single Pulse Avalanche Energy ²	1300	mJ

1) Repetitive Rating: Pulse Width limited by maximum junction temperature.

2) Starting $T_J = 25^\circ\text{C}$, $L = 8.49\text{mH}$, $R_G = 25\Omega$, Peak $I_L = 17.5\text{A}$



**SEME
LAB**

SML60A18

STATIC ELECTRICAL RATINGS ($T_{case} = 25^\circ C$ unless otherwise stated)

	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain – Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	600			V
I_{DSS}	Zero Gate Voltage Drain Current ($V_{GS} = 0V$)	$V_{DS} = V_{DSS}$			25	μA
		$V_{DS} = 0.8V_{DSS}, T_C = 125^\circ C$			250	
I_{GSS}	Gate – Source Leakage Current	$V_{GS} = \pm 30V, V_{DS} = 0V$			± 100	nA
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 1.0mA$	2		4	V
$I_{D(ON)}$	On State Drain Current ²	$V_{DS} > I_{D(ON)} \times R_{DS(ON)}$ Max $V_{GS} = 10V$	17.5			A
$R_{DS(ON)}$	Drain – Source On State Resistance ²	$V_{GS} = 10V, I_D = 0.5 I_D$ [Cont.]			0.320	Ω

DYNAMIC CHARACTERISTICS

	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input Capacitance	$V_{GS} = 0V$		3750	4500	pF
C_{oss}	Output Capacitance			430	600	
C_{rss}	Reverse Transfer Capacitance			160	240	
Q_g	Total Gate Charge ³	$V_{GS} = 10V$		150	225	nC
Q_{gs}	Gate – Source Charge			18	27	
Q_{gd}	Gate – Drain (“Miller”) Charge			60	90	
$t_{d(on)}$	Turn-on Delay Time			12	24	ns
t_r	Rise Time	$V_{DD} = 0.5 V_{DSS}$		10	20	
$t_{d(off)}$	Turn-off Delay Time			47	75	
t_f	Fall Time	$I_D = I_D$ [Cont.] @ $25^\circ C$		8	16	

SOURCE – DRAIN DIODE RATINGS AND CHARACTERISTICS

	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	(Body Diode)			17.5	A
I_{SM}	Pulsed Source Current ¹				70	
V_{SD}	Diode Forward Voltage ²	$V_{GS} = 0V, I_S = -I_D$ [Cont.]			1.3	V
t_{rr}	Reverse Recovery Time	$I_S = -I_D$ [Cont.], $dI_S / dt = 100A/\mu s$		475		ns
Q_{rr}	Reverse Recovery Charge	$I_S = -I_D$ [Cont.], $dI_S / dt = 100A/\mu s$			10	μC

THERMAL CHARACTERISTICS

	Characteristic	Min.	Typ.	Max.	Unit
$R_{\theta JC}$	Junction to Case	0.53			$^\circ C/W$
$R_{\theta JA}$	Junction to Ambient				

1) Repetitive Rating: Pulse Width limited by maximum junction temperature.

2) Pulse Test: Pulse Width < $380\mu s$, Duty Cycle < 2%

3) See MIL-STD-750 Method 3471



CAUTION — Electrostatic Sensitive Devices. Anti-Static Procedures Must Be Followed.

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